

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE			
TRANSMITTAL OF REPLY UNDER 37 C.F.R. § 1.116 AND REQUEST FOR EXTENSION OF TIME PURSUANT TO 37 C.F.R. § 1.136(a)		Attorney Docket Number: 10191/3964	
Application Number 10/530,612	Filing Date December 30, 2005	Examiner Maki A. Angadi	Art Unit 1792
Invention Title PLASMA SYSTEM AND METHOD FOR ANISOTROPICALLY ETCHING STRUCTURES INTO A SUBSTRATE		Inventor(s) Franz LAERMER et al.	

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I hereby certify that this correspondence is being electronically transmitted to the United States Patent and Trademark Office via the Office electronic filing system on <u>May 4, 2009</u> . Signature: <u>/Gerard A. Messina/</u>

TRANSMITTAL OF REPLY UNDER 37 C.F.R. § 1.116

S I R:

Submitted herewith is an **Amendment** in response to the Final Office Action of December 3, 2008 in the above-identified patent application.

Applicants respectfully request a **two-month extension of time** in which to reply to the Office Action, extending the three month response period expiring on March 3, 2009 to May 4, 2009 (May 3, 2009 was a Sunday).

The 37 C.F.R. § 1.136(a) two-month extension fee of **\$490.00** is being paid by credit card.

The Commissioner is also authorized to charge any additional fees or credit any overpayment in connection with this paper to Deposit Account No. **11-0600**.

Respectfully submitted,

Dated: May 4, 2009

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